

# Specifications for Approval

Customer Part No.:

JOINHANDS Part No.: JH-CB65C08GTP001

Part Name: 2012 蓝光 LED

Spec Issue Date:2019-01-08

Revision No.: A0

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To Customer:

1. Accessory: Samples  Samples Data
2. Customer's Proposal :Agree Disagree

Reason :

Draw by :	Checked by :	Approved by :
李飞	卢伟昌	钟志鸿
Customer Approve		



广东晶瀚光电科技有限公司

GUANGDONG JOINHANDS Optoelectronics Technology Co.,Ltd

地址:东莞市寮步镇塘边社区华南工业城金富路 13 号

鼎昊自动化孵化园 2 区 B 栋 101 号

Tel:0769-82233086 Fax:0769-82233606

[Https://www.joinhands-cn.com](https://www.joinhands-cn.com)

E-mail:hanser.yu@joinhands-cn.com

**Features**

2.0mm × 1.25mm SMD LED, 0.8mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

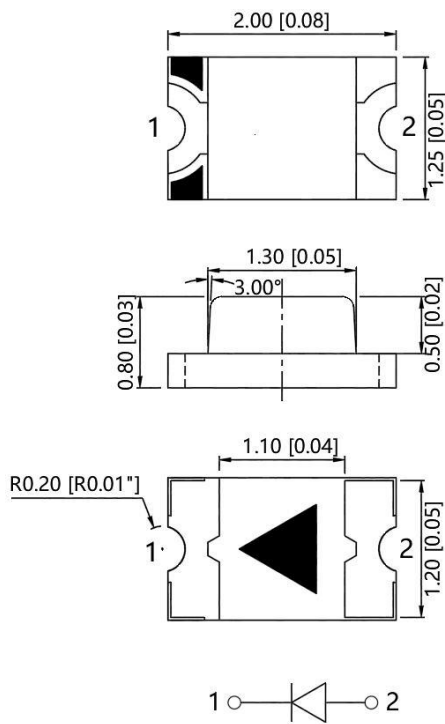
RoHS Compliant

**Applications**

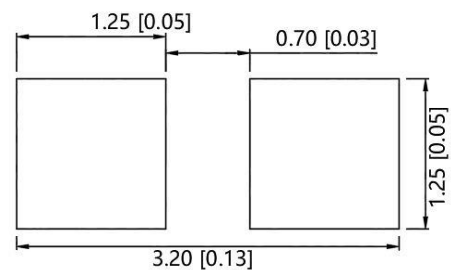
Ideal for back light and indicator

Various colors and lens types available

**Package outlines**



**Recommend Pad Layout**



Part No.	Emitted color	Dice	Lens color
JH-CB65C08GTP001	Blue	InGaN/GaN	Water transparent

**Notes:**

1. All dimensions are in millimeters (inches);
2. Tolerances are ±0.1mm (0.004inch) unless otherwise noted.

**Absolute Maximum Ratings (Ta=25°C)**

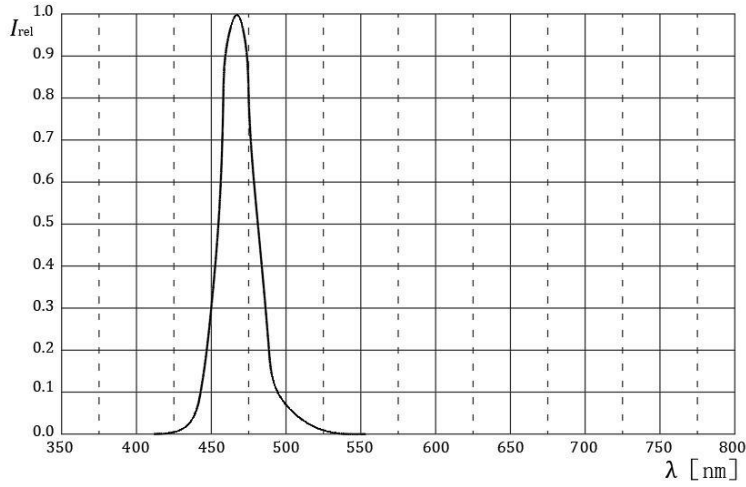
Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	108	mW
Operating temperature	Top	-40 ~+85	°C
ESD(Human-body mode)	--	2	KV
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	If=20mA	$\lambda_p$	--	465	--	nm
Spectral half bandwidth	If=20mA	$\Delta \lambda$	--	25	--	nm
Dominant wavelength	If=20mA	$\lambda_d$	464	--	474	nm
Forward voltage	If=20mA	Vf	2.8	--	3.6	V
Luminous intensity	If=20mA	Iv	80	120	200	mcd
Viewing angle at 50% Iv	If=10mA	2 $\theta_{1/2}$	--	120	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	$\mu$ A

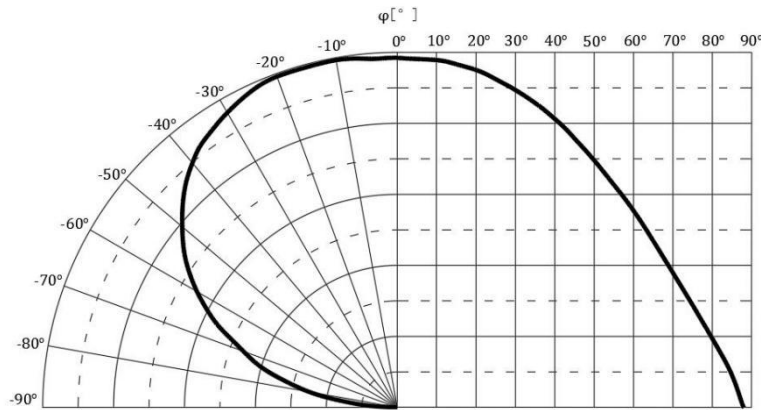
**Relative Spectral Emission**

IF=20mA, Ta=25°C



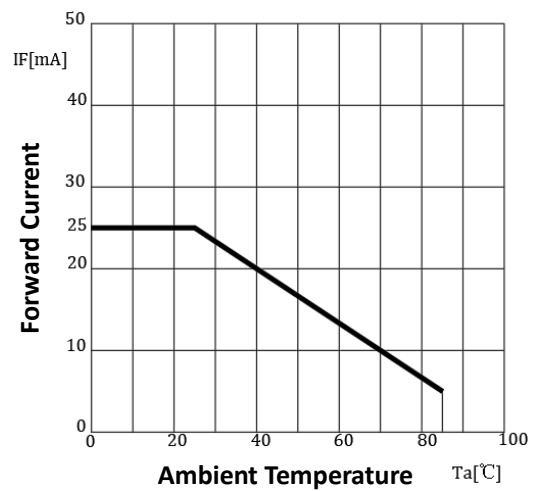
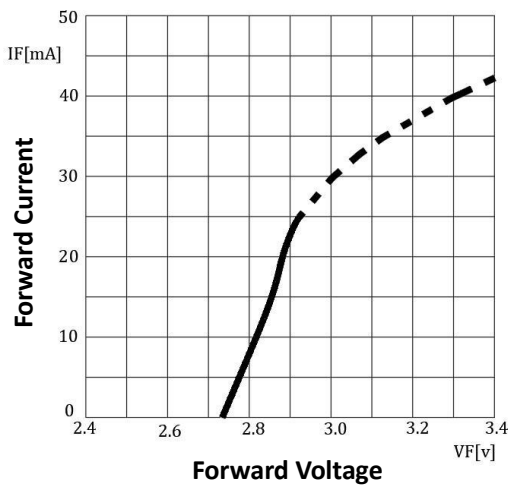
**Radiation Characteristics**

IF=10mA, Ta=25°C



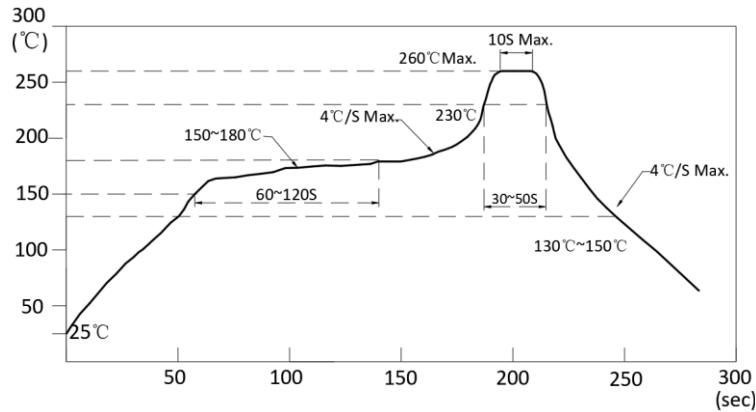
**Forward Current vs Forward Voltage Forward Current Derating Curve**

Ta=25°C



**Reflow Profile**

■ Reflow Temp/Time



Notes:

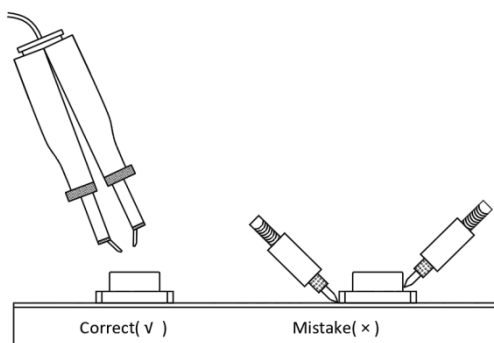
1. We recommend the reflow temperature 245°C(±5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

■ Soldering iron

Basic spec is ≤ 5sec when 320°C(±20°C). If temperature is higher, time should be shorter(+10°C → -1sec). Powerdissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 350°C.

■ Rework

1. Customer must finish rework within 5 sec under 340°C.
2. The head of iron cannot touch copper foil
3. Twin-head type is preferred.

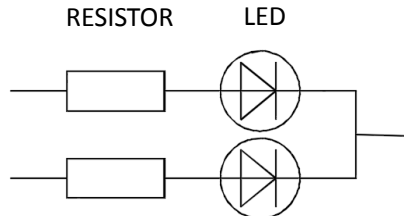


- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

## Handling precautions

### 1. Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit below.



### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 60% RH or less.

2.3 After the package is opened, the products should be used within a week or they should be kept to store at  $\leq 20$  R.H. with zip-lock sealed.

### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 60±3°C x(12~24hrs) and <5%RH, taped reel type

3.2 100±3°C x(45min~1hr), bulk type

3.3 130±3°C x(15~30min), bulk type

## Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min ↑→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃~100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH	--	1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

### Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
H	2.8	2.9	V
I	2.9	3.0	
J	3.0	3.1	
K	3.1	3.2	
L	3.2	3.3	
M	3.3	3.4	
N	3.4	3.5	
O	3.5	3.6	

### Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
I	80	100	mcd
J	100	125	
K	125	160	
L	160	200	

### Dominant wavelength Rank Combination(IF=20mA)

Rank	Min.	Max.	Unit
Bh	464	466	nm
Bi	466	468	
Bj	468	470	
Bk	470	472	
Bl	472	474	

### Group Name on Label ( Example DATA: KLBi 20 )

DATA: KLBi20	Vf(V)	Iv (mcd)	$\lambda_d$ (nm)	Test Condition
K→L→Bi→20	3.1~3.2	160~200	466~468	IF=20mA

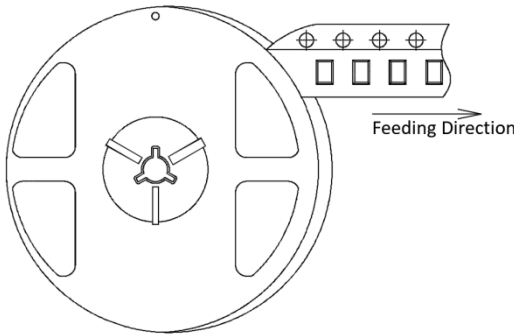
#### Notes:

1. The tolerance of luminous intensity (Iv )is  $\pm 15\%$  .
2. The tolerance of dominant wavelength is  $\pm 1\text{nm}$ .
3. This specification is preliminary.
4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

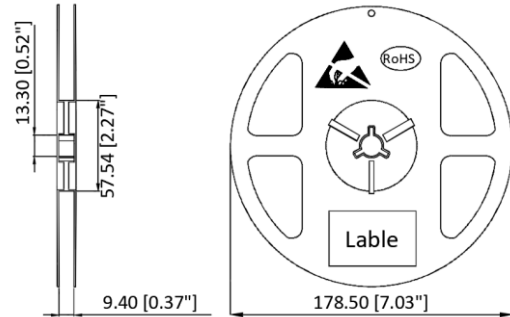


**2012 Series SMD Chip LED Lamps Packaging Specifications**

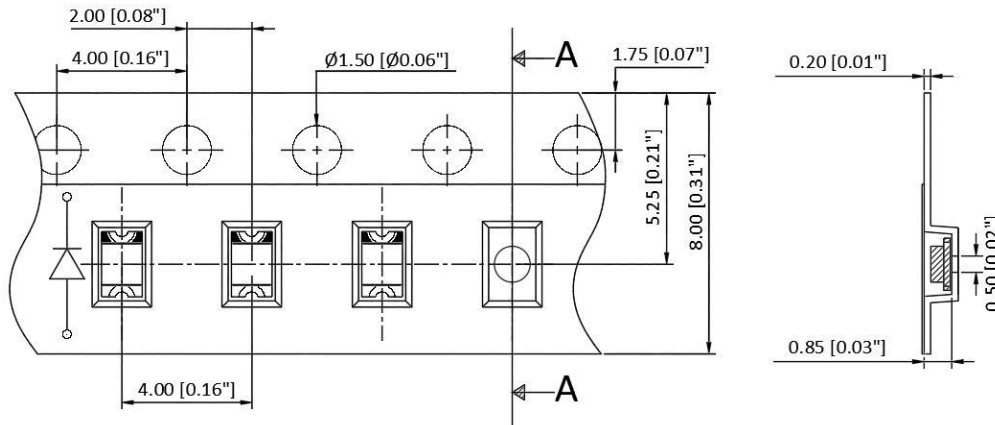
● **Feeding Direction**



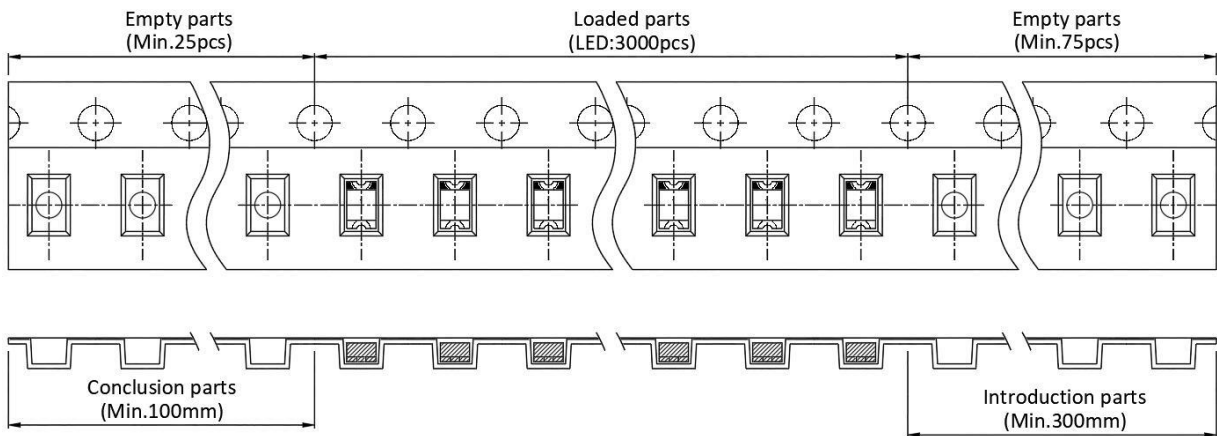
● **Dimensions of Reel (Unit: mm)**



● **Dimensions of Tape (Unit: mm)**



● **Arrangement of Tape**



**Notes:**

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 3,000pcs/Reel.

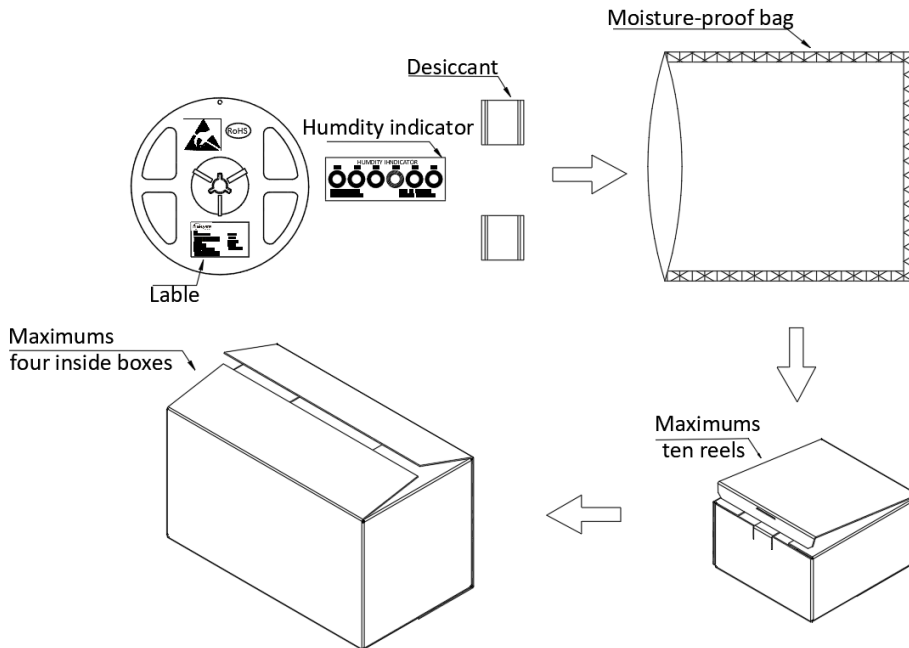
## 2012 Series SMD Chip LED Lamps Packaging Specifications

- Label Explanation



CPN:Customer's Product Number  
P/N:Product Number  
QTY:Packing Quantity  
LOT NO:Lot Number  
VF:Forward Voltage Rank  
IV:Luminous Intensity Rank  
WLD:Dom. Wavelength Rank  
BIN:BIN Code  
DATE:Date Of Dispatch

- Transportation Packing



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with two desiccant one by one, ten moisture-proof bag of maximums packed in an inside box (about size: 240x 220x 120mm) and four inside boxes of maximums are put in the outside box (about size: 460mm x 246mm x 250mm) Together with buffer material, and it is packed. The number of the loading steps of outsidebox (cardboard box) has it to three steps.